

# 3A, 50V - 600V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Ultra fast recovery time for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, and telecommunication

#### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- · Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I <sub>F</sub>	3	Α		
$V_{RRM}$	50 - 600	V		
I <sub>FSM</sub>	75	Α		
T <sub>J MAX</sub>	175	°C		
Package	DO-214AB (SMC)			
Configuration	Single die			









DO-214AB (SMC)



	OVMBOL	MUR	MUR	MUR	MUR	MUR	MUR	
PARAMETER	SYMBOL	305S	3105	3158	3205	340\$	360\$	UNIT
Marking code on the device		MUR 305S	MUR 310S	MUR 315S	MUR 320S	MUR 340S	MUR 360S	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	105	140	280	420	V
Forward current	I <sub>F</sub>	3				Α		
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	75					А	
Junction temperature	$T_J$	- 55 to +175				°C		
Storage temperature	T <sub>STG</sub>	- 55 to +175				°C		

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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	11	°C/W

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	MUR305S MUR310S MUR315S MUR320S	I <sub>F</sub> = 3A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	0.875	V
Forward voltage <sup>(1)</sup>	MUR340S MUR360S			-	1.250	V
Forward voltage <sup>(1)</sup>	MUR305S MUR310S MUR315S MUR320S	I <sub>F</sub> = 3A, T <sub>J</sub> = 150°C	V <sub>F</sub>	-	0.710	V
	MUR340S MUR360S			-	1.050	V
	MUR305S MUR310S MUR315S MUR320S T <sub>J</sub> = 25°C I <sub>R</sub>	I <sub>R</sub>	-	5	μA	
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	MUR340S MUR360S			-	10	μA
	MUR305S MUR310S MUR315S MUR320S	T <sub>J</sub> = 150°C	I <sub>R</sub>	-	150	μA
	MUR340S MUR360S			-	250	μA
Reverse recovery time	MUR305S MUR310S MUR315S MUR320S	$I_F = 0.5A, I_R = 1.0A$ $I_{rr} = 0.25A$	t <sub>rr</sub>	-	25	ns
	MUR340S MUR360S	1 <sub>III</sub> – 0.23/1		-	50	ns

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE(1)	PACKAGE	PACKING			
MUR3xS	DO-214AB (SMC)	3,000 / Tape & Reel			

### Notes:

1. "x" defines voltage from 50V(MUR305S) to 600V(MUR360S)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

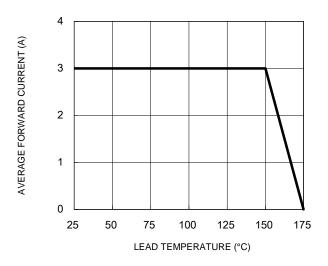


Fig.3 Typical Reverse Characteristics

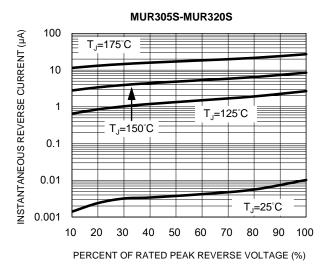
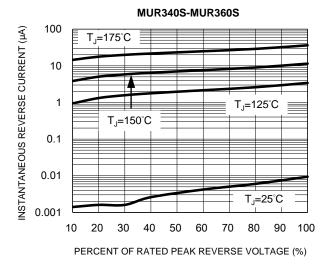


Fig.5 Typical Reverse Characteristics



**Fig.2 Typical Junction Capacitance** 

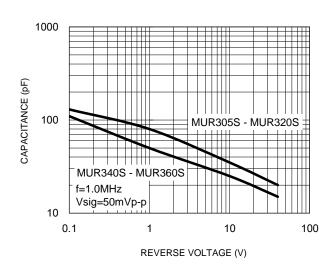


Fig.4 Typical Forward Characteristics

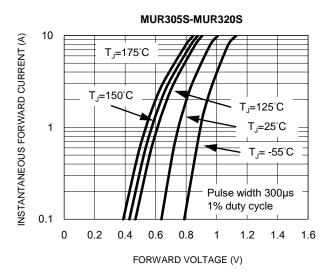
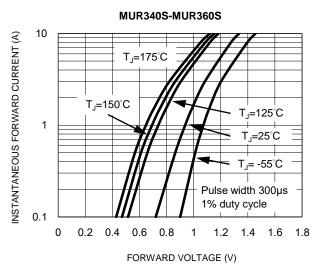


Fig.6 Typical Forward Characteristics

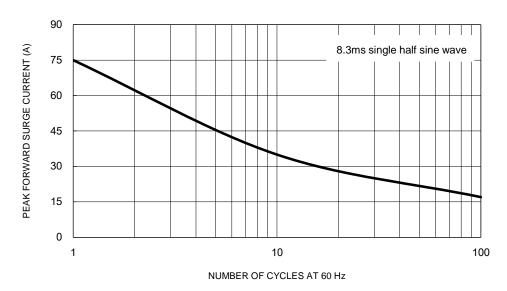




## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

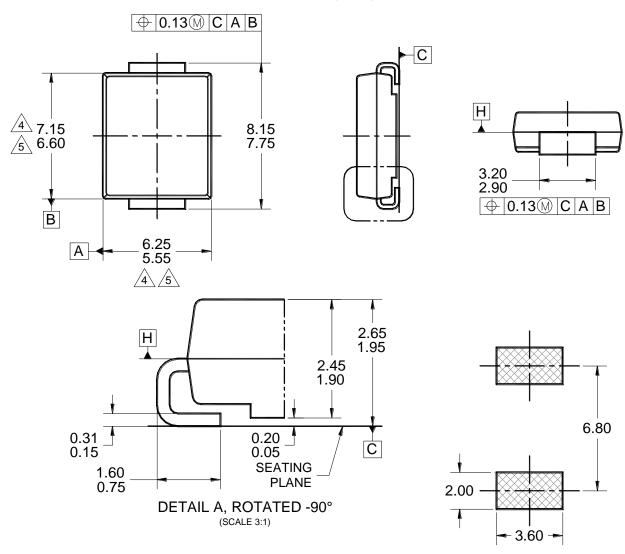
Fig.7 Maximum Non-Repetitive Forward Surge Current

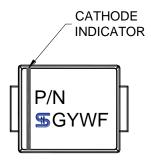




#### **PACKAGE OUTLINE DIMENSIONS**

## **DO-214AB (SMC)**





#### MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND

YW = DATE CODE F = FACTORY CODE

#### NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.

SUGGESTED PAD LAYOUT

- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- 5 MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
  - 6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.



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MUR305S R7 MUR310S R7 MUR315S R7 MUR320S R7 MUR340S R7 MUR360S R7 MUR310S R7G

MUR320S R6 MUR310S R6G MUR320S R7G MUR315S R6 MUR310S R6 MUR315S R6G MUR305S R6G

MUR360S R6 MUR305S R6 MUR305S R7G MUR340S R6G MUR360S R7G MUR360S R6G MUR340S R6

MUR320S R6G MUR315S R7G MUR340S R7G MUR320S V6G MUR320S V7G MUR340S V6G MUR340S V7G

MUR360S V7G MUR315S V7G MUR305S V6G MUR305S V7G MUR310S V7G MUR315S V6G

MUR360S V6G MUR305S MUR310S MUR315S MUR320S MUR340S MUR360S